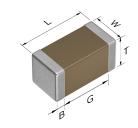
积层贴片陶瓷片式电容器

C1608X6S0J225K080AB

RoHS Reach Halogen Free Pb Free

交货型号	C1608X6S0J225KT****	
用途	一般等级	
特点	General 一般(~75V)	
系列	C1608 [EIA 0603]	
状态	↑ 量产体制(新设计非推荐) 推荐代替型号 : C1608X6S1C225K080AC (不保证其兼容性。)	



尺寸		
长度(L)	1.60mm ± 0.10 mm	
宽度(W)	$0.80 \text{mm} \pm 0.10 \text{mm}$	
厚度(T)	$0.80 \text{mm} \pm 0.10 \text{mm}$	
端子宽度(B)	0.20mm Min.	
端子间隔(G)	0.30mm Min.	
推荐焊盘布局(PA)	0.70mm to 1.00mm(Flow Soldering)	
推存序益和向 (FA)	0.60mm to 0.80mm(Reflow Soldering)	
推荐焊盘布局(PB)	0.80mm to 1.00mm(Flow Soldering)	
]此行, 产血、相, 问, (t D)	0.60mm to 0.80mm(Reflow Soldering)	
推荐焊盘布局(PC)	0.60mm to 0.80mm(Flow Soldering)	
3世代/广重/印/四 U U/	0.60mm to 0.80mm(Reflow Soldering)	

电气特性		
电容	$2.2\muF~\pm10\%$	
额定电压	6. 3VDC	
温度特性	X6S (±22%)	
耗散因数 (Max.)	10%	
绝缘电阻 (Min.)	45M Ω	

	其他	
焊接方法	流体	
件按月伝	回流	
AEC-Q200	NO	
包装形式	纸编带 (180mm卷筒)	
包装个数	4000pcs	

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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特性图表(这是参考数据,并不保证产品的特性。)

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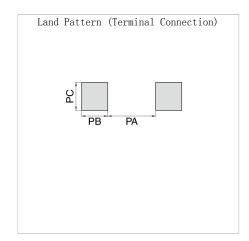
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Associated Images



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